Surface mount LVF Schottky diode Reverse Voltage-40to200v Forward current-2A

Features

LVF Schottky chip

Low VF, Low power losses, high efficiency Ldeal for surface mounted applications Plastic Case Material has UL Flammability

Mechanical Data

Package: SMAF

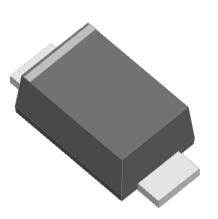
Terminals:Tin Plated leads, solderable per

Mil-STD-750 Method 2026

Polarity: As marked

Molding compound meets UL 94 V-0 flammability rating,

ROHS-compliant





Maximum Ratings (Ta=25℃ Unless otherwise specified)

JJu,							
SYMBOL	SS24L	SS26L	SS28L	SS210L	SS215L	SS220L	Umit
V_{RRM}	40	60	80	100	150	200	V
V_{RMS}	28	42	56	70	105	140	V
V _{DC}	40	60	80	100	150	200	V
IO _(AV)	2.0					Α	
IFSM	40.0					Α	
	80.0				Α		
l ² t	6.6					A ² S	
V_{FM}	0.45	0.55	0.	65	0.	85	V
ID	0.2 0.1		mA				
i ir	50 20			mA			
R_{QJA}	65.0		°C/W				
T_J	—55to+150			$^{\circ}$			
T _{STG}	—55to+150			$^{\circ}$			
	SYMBOL V _{RRM} V _{RMS} V _{DC} IO _(AV) IFSM I ² t V _{FM} IR R _{QJA} T _J	SYMBOL SS24L V _{RRM} 40 V _{RMS} 28 V _{DC} 40 IO _(AV) IFSM I ² t V _{FM} 0.45 IR 0 R _{QJA} T _J	SYMBOL SS24L SS26L V _{RRM} 40 60 V _{RMS} 28 42 V _{DC} 40 60 IO _(AV) IFSM IFSM 0.45 0.55 IR 0.2 50 R _{QJA} T _J T _J	SYMBOL SS24L SS26L SS28L V _{RRM} 40 60 80 V _{RMS} 28 42 56 V _{DC} 40 60 80 IO _(AV) 2 4 IFSM 4 6 V _{FM} 0.45 0.55 0. IR 50 6 -55	SYMBOL SS24L SS26L SS28L SS210L V _{RRM} 40 60 80 100 V _{RMS} 28 42 56 70 V _{DC} 40 60 80 100 IO _(AV) 2.0 40.0 IFSM 80.0 80.0 I ² t 6.6 6.6 V _{FM} 0.45 0.55 0.65 IR 50 2 R _{QJA} 65.0 -55to+150	SYMBOL SS24L SS26L SS28L SS210L SS215L V _{RRM} 40 60 80 100 150 V _{RMS} 28 42 56 70 105 V _{DC} 40 60 80 100 150 IO _(AV) 2.0 40.0 40.0 IFSM 80.0 80.0 66.6 66 V _{FM} 0.45 0.55 0.65 0.0 IR 0.2 0.1 0.1 0.1 0.1 R _{QJA} 65.0 -55to+150 -55to+150	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

FIG. 1MAXIMUM AVERAGE FORWARD CURRENT DERATING

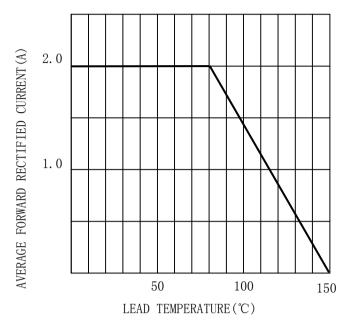


FIG. 2TYPICAL FORWARD CHARACTERISTICS

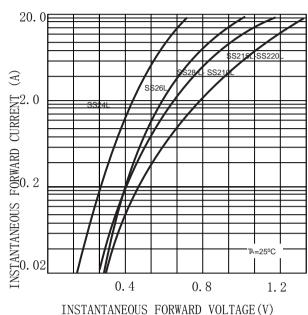


FIG. 3MAXIMUM NON-REPEITIVE SURGE CURRENT

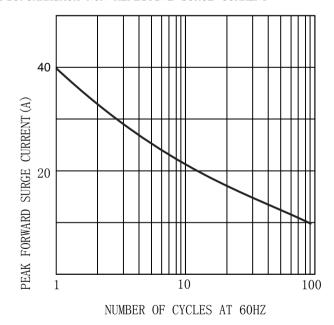
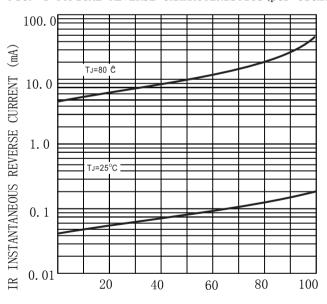


FIG. 4 TYPICAL REVERSE CHARACTERISTICS (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

MARKING INFORMATION



= Logo

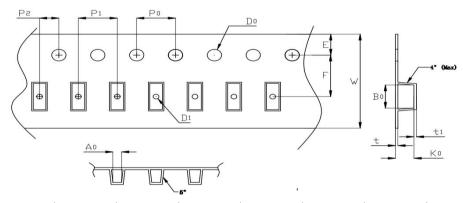
**** = Date Code Marking

SS**L = Marking Code

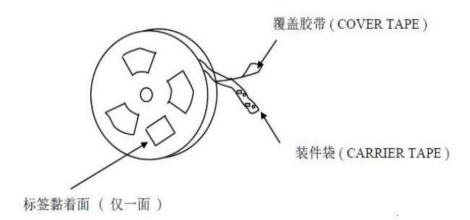
Print according to customer request

PACKING REQUIRMENTS

Carrier tape packing



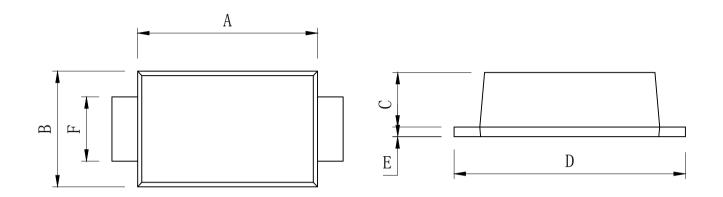
Specificati ons	Carrier tape type	Ao	Во	Ko	Ро	W	t	Exiplain
SMAF	Anti-static	2.83± 0.10	4.9± 0.10	1.45± 0.05	4.00± 0.10	12.0± 0.10	0.23± 0.05	



	Tape		13"Reel		7"Reel			
	width	Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)	Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)	
SMAF	12mm	10000	20	200000	3000	64	192000	

Outline Dimensions

SMAF



SMAF							
DIM	INC	HES	MM				
	MIN	MAX	MIN	MAX			
A	0. 13	0. 15	3.2	3.8			
В	0.09	0. 11	2.3	2. 7			
С	0.03	0.05	0.8	1.2			
D	0. 16	0.20	4	5			
Е	/	0.01	/	0.3			
F	0.04	0.08	1	2			

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